

N-Channel 80V(D-S) MOSFET
GENERAL DESCRIPTION

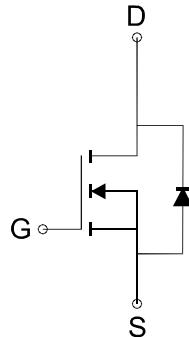
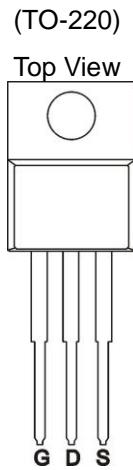
The ME80N08A is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching and low in-line power loss are needed in a very small outline surface mount package.

FEATURES

- $R_{DS(ON)} \leq 5\text{m}\Omega @ V_{GS}=10\text{V}$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Power Management in Note book
- DC/DC Converter
- Load Switch
- LCD Display inverter

PIN CONFIGURATION

N-Channel MOSFET
Ordering Information: ME80N08A (Pb-free)

ME80N08A-G (Green product-Halogen free)

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Maximum Ratings	Unit
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current*	I_D	194	A
		162	
Pulsed Drain Current ^a	I_{DM}	776	A
Power Dissipation	P_D	300	W
		210	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	°C
Thermal Resistance-Junction to Case**	R_{JC}	0.5	°C/W

* Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 80A.

 ** The device mounted on 1in² FR4 board with 2 oz copper.

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Electrical Characteristics (T_J=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250 μA	80			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250 μA	2.0		4.0	V
I _{GSS}	Gate-Body Leakage	V _{GS} =±20V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =80V, V _{GS} =0V			1	μA
R _{D(S(ON))}	Drain-Source On-Resistance*	V _{GS} =10V, I _D =80A		3.9	5	mΩ
V _{SD}	Diode Forward Voltage *	I _S =40A, V _{GS} =0V		0.8	1.2	V
DYNAMIC						
Q _G	Total Gate Charge	V _{DD} =40V, V _{GS} =10V, I _D =80A		221		nC
Q _G	Total Gate Charge	V _{DD} =40V, V _{GS} =4.5V, I _D =80A		56		
Q _{GS}	Gate-Source Charge			63		
Q _{GD}	Gate-Drain Charge			55		
C _{ISS}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz		12500		pF
C _{OSS}	Output Capacitance			1150		
C _{rss}	Reverse Transfer Capacitance			375		
t _{d(on)}	Turn-On Delay Time	V _{GS} =10V, R _L =20Ω V _{DD} =40V, R _G =3.3Ω		65		ns
t _r	Turn-On Rise Time			43		
t _{d(off)}	Turn-Off Delay Time			196		
t _f	Turn-Off Fall Time			53		

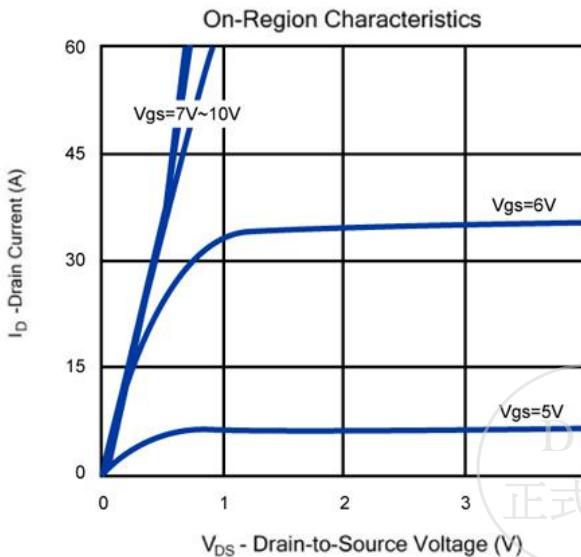
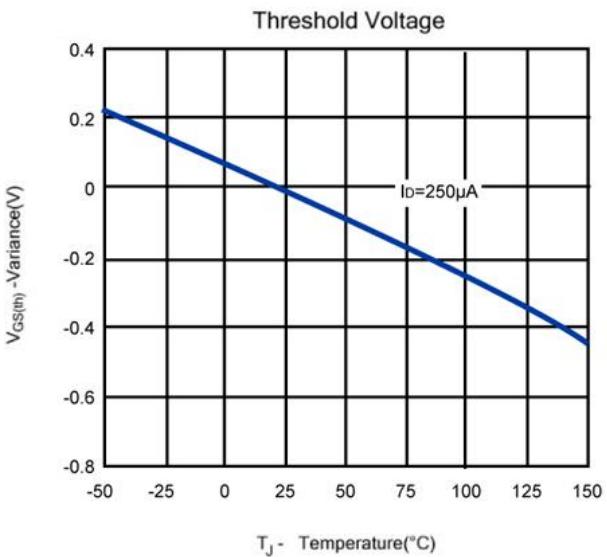
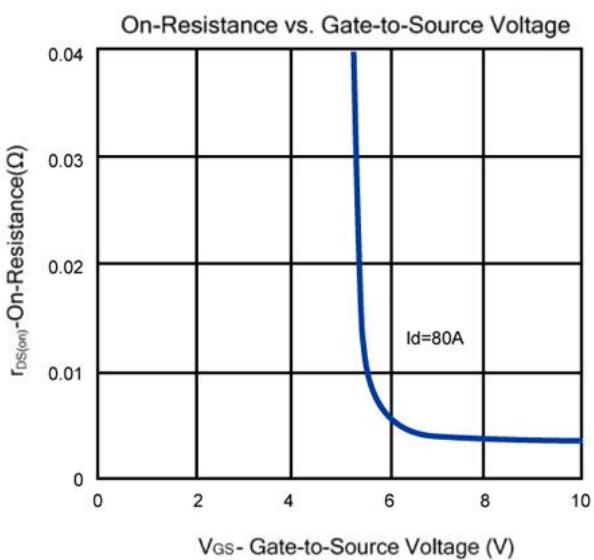
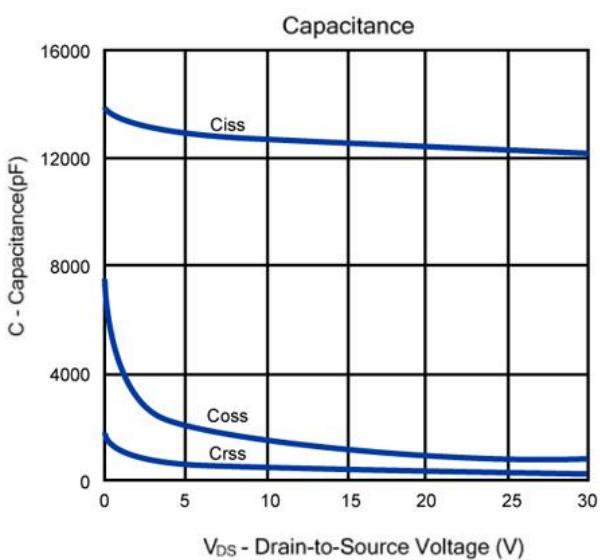
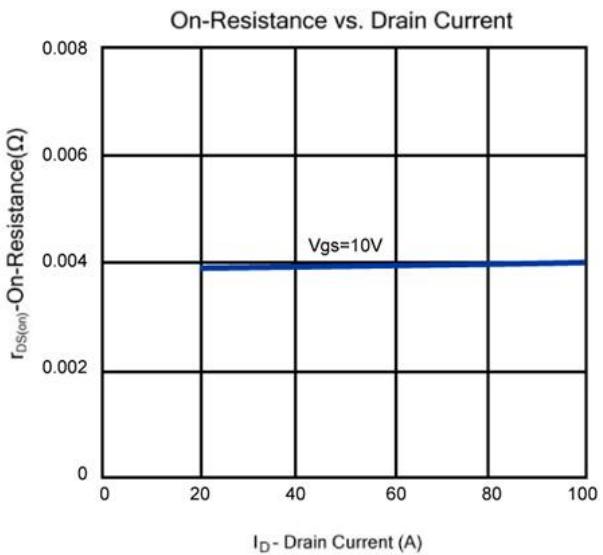
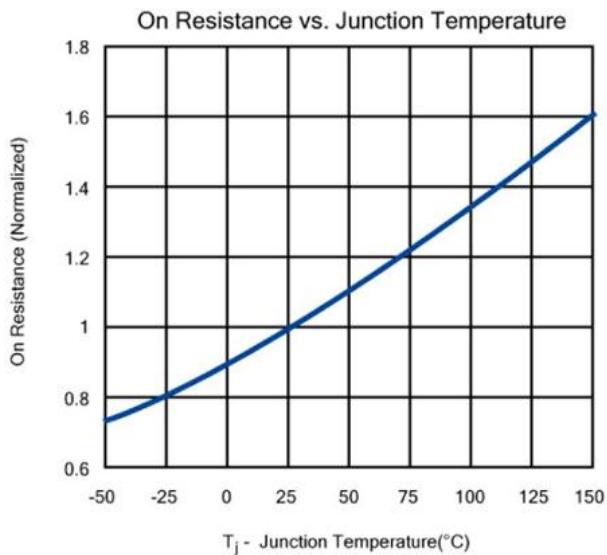
Notes: a. pulse test: pulse width ≤ 300us, duty cycle ≤ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



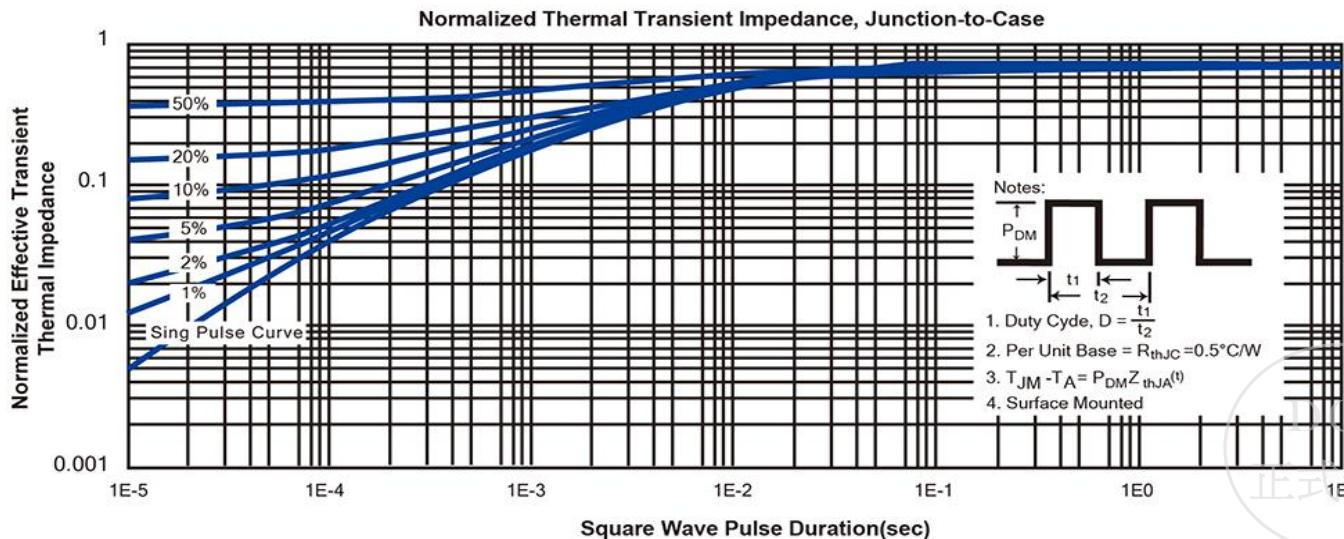
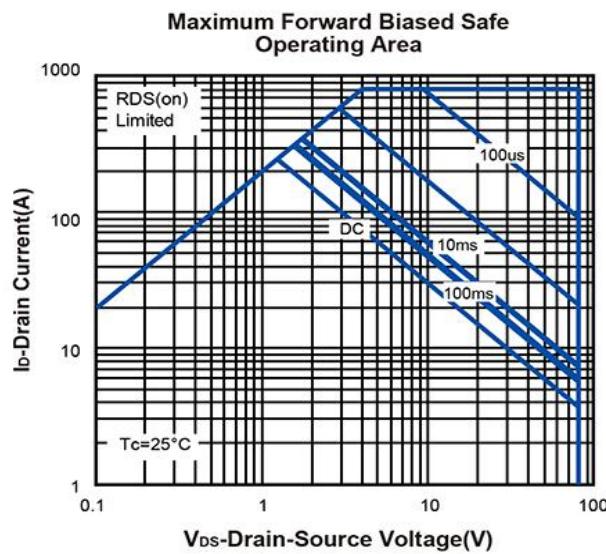
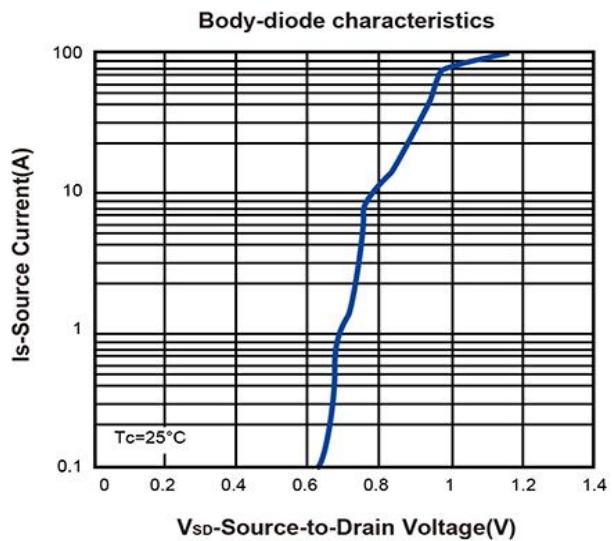
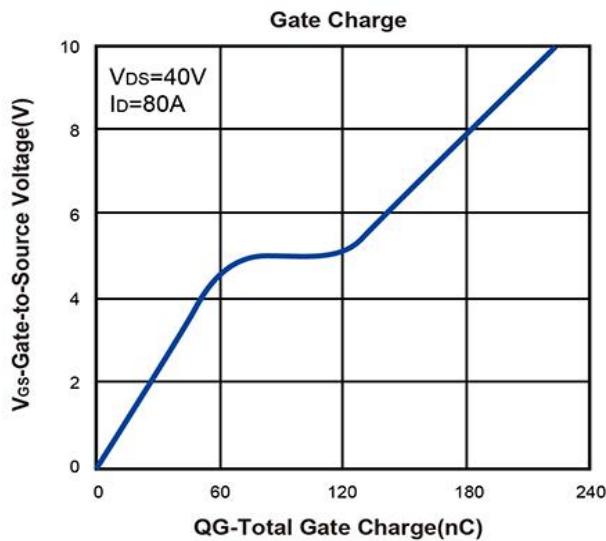
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Typical Characteristics (T_J =25°C Noted)

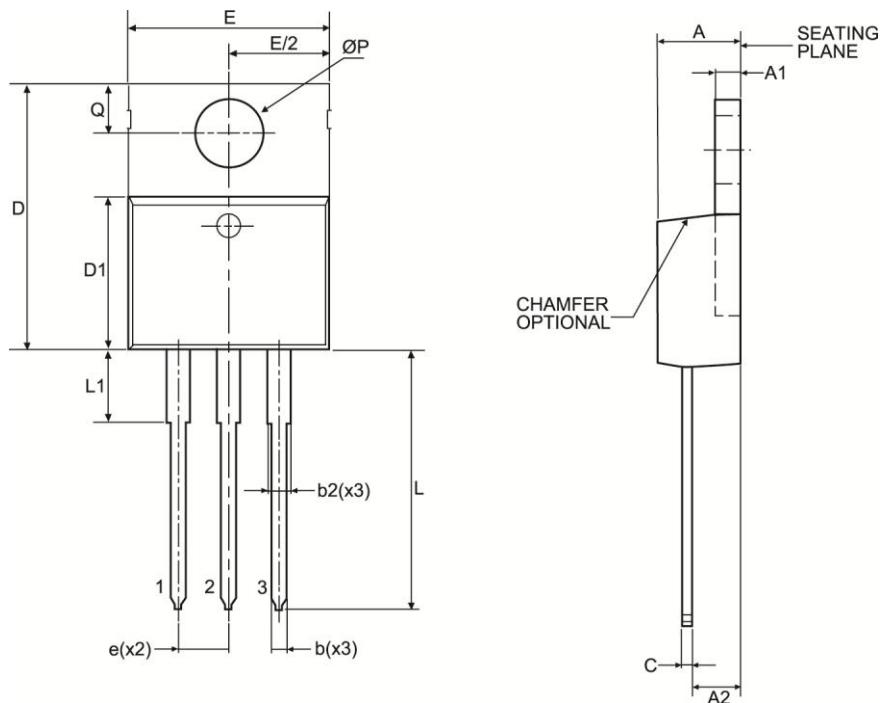


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TO-220 Package Outline



Symbol	MILLIMETERS (mm)	
	MIN	MAX
A	3.50	4.90
A1	1.00	1.40
A2	2.00	3.00
b	0.70	1.40
c	0.35	0.65
D	14.00	16.50
D1	8.30	9.50
E	9.60	10.70
e	2.54 BSC	
L	12.50	15.00
ØP	3.60 TYP	
Q	2.50	3.10
b2	1.10	1.80
L1	2.40	3.20

